SCBS143E - MAY 1992 - REVISED JANUARY 1996

<ul> <li>State-of-the-Art Advanced BiCMOS Technology (ABT) Design for 3.3-V Operation and Low-Static Power</li> </ul>	SN54LVT16245A WD PACKAGE SN74LVT16245A DGG OR DL PACKAGE (TOP VIEW)				
Dissipation					
Members of the Texas Instruments					
<i>Widebus</i> ™ Family					
Support Mixed-Mode Signal Operation (5-V					
Input and Output Voltages With 3.3-V $V_{CC}$ )					
<ul> <li>Support Unregulated Battery Operation</li> </ul>					
Down to 2.7 V					
	$V_{CC}$ 7 42 $V_{CC}$				
• Typical V <sub>OLP</sub> (Output Ground Bounce)					
< 0.8 V at V <sub>CC</sub> = 3.3 V, T <sub>A</sub> = 25°C					
ESD Protection Exceeds 2000 V Per					
MIL-STD-883C, Method 3015; Exceeds					
200 V Using Machine Model	1B8 12 37 1A8				
(C = 200 pF, R = 0)	2B1 13 36 2A1				
Latch-Up Performance Exceeds 500 mA					
Per JEDEC Standard JESD-17					
Bus-Hold Data Inputs Eliminate the Need	2B3 [ 16 33 ] 2A3				
for External Pullup Resistors	2B4 [ 17 32 ] 2A4				
<ul> <li>Support Live Insertion</li> </ul>	$V_{CC}$ 18 31 $V_{CC}$				
••					
<ul> <li>Distributed V<sub>CC</sub> and GND Pin Configuration</li> </ul>					
Minimizes High-Speed Switching Noise					
<ul> <li>Flow-Through Architecture Optimizes</li> </ul>	2B7 22 27 2A7				
PCB Layout					
Packaged in Plastic 300-mil Shrink	2DIR 24 25 20E				

Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

#### description

The 'LVT16245A are 16-bit (dual-octal) noninverting 3-state transceivers designed for low-voltage (3.3-V)  $V_{
m CC}$ operation, but with the capability to provide a TTL interface to a 5-V system environment.

These devices can be used as two 8-bit transceivers or one 16-bit transceiver. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending upon the logic level at the direction-control (DIR) input. The output-enable  $(\overline{OE})$  input can be used to disable the device so that the buses are effectively isolated.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.



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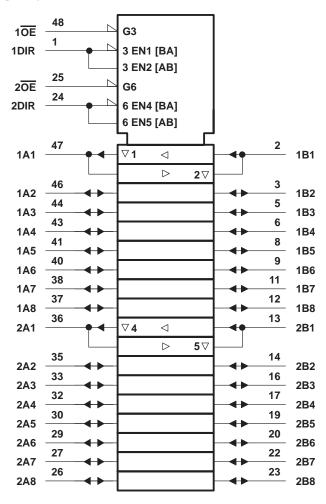
#### description (continued)

The SN74LVT16245A is available in TI's shrink small-outline (DL) and thin shrink small-outline (DGG) packages, which provide twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

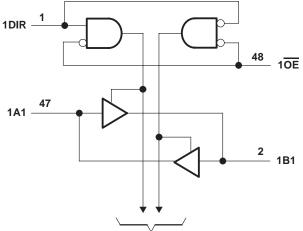
The SN54LVT16245A is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C. The SN74LVT16245A is characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C.

FUNCTION TABLE (each 8-bit section)							
INP	UTS						
OE	DIR	OPERATION					
L	L	B data to A bus					
L	Н	A data to B bus					
н	Х	Isolation					

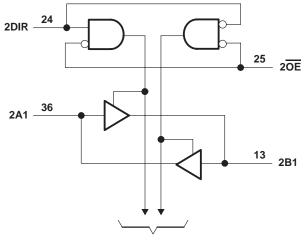
#### logic symbol<sup>†</sup>



## logic diagram (positive logic)



**To Seven Other Channels** 



**To Seven Other Channels** 

<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, V <sub>CC</sub>	
Input voltage range, V <sub>I</sub> (see Note 1) –0.5	, V to 7 V
Voltage range applied to any output in the high state or power-off state, V <sub>O</sub> (see Note 1)0.5	V to 7 V
Current into any output in the low state, IO: SN54LVT16245A	. 96 mA
SN74LVT16245A	128 mA
Current into any output in the high state, I <sub>O</sub> (see Note 2): SN54LVT16245A	. 48 mA
SN74LVT16245A	. 64 mA
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	-50 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)	-50 mA
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 3): DGG package	. 0.85 W
DL package	1.2 W
Storage temperature range, T <sub>stg</sub> 65°C	to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. This current flows only when the output is in the high state and  $V_O > V_{CC}$ .

The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. 3. For more information, refer to the Package Thermal Considerations application note in the 1994 ABT Advanced BiCMOS Technology Data Book, literature number SCBD002B.

#### recommended operating conditions (see Note 4)

			SN54LV	SN54LVT16245A		SN74LVT16245A		
			MIN	MAX	MIN	MAX	UNIT	
VCC	Supply voltage		2.7	3.6	2.7	3.6	V	
VIH	High-level input voltage		2		2		V	
VIL	Low-level input voltage			0.8		0.8	V	
VI	Input voltage			5.5		5.5	V	
ЮН	High-level output current			-24		-32	mA	
IOL	Low-level output current			48		64	mA	
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V	
TA	Operating free-air temperature		-55	125	-40	85	°C	

NOTE 4: Unused control inputs must be held high or low to prevent them from floating.



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#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETER		SN5	4LVT162	45A	SN74					
PARAMETER	1	MIN	түр†	MAX	( MIN TYP <sup>†</sup> MAX		MAX	UNIT		
VIK	V <sub>CC</sub> = 2.7 V,	lj = -18 mA			-1.2			-1.2	V	
	$V_{CC} = MIN \text{ to } MAX^{\ddagger}$	, I <sub>OH</sub> = -100 μA		V <sub>CC</sub> -0	).2		VCC-0	.2		
Maria	$V_{CC} = 2.7 \text{ V}, \qquad I_{OH} = -8 \text{ mA}$			2.4			2.4			v
VOH	V <sub>CC</sub> = 3 V	I <sub>OH</sub> = - 24 mA		2						v
	vCC = 2 v	$I_{OH} = -32 \text{ mA}$					2			
	Vec - 27V	I <sub>OL</sub> = 100 μA				0.2			0.2	
	$V_{CC} = 2.7 V$	I <sub>OL</sub> = 24 mA				0.5			0.5	
Max		I <sub>OL</sub> = 16 mA				0.4			0.4	v
VOL		I <sub>OL</sub> = 32 mA				0.5			0.5	V
	$V_{CC} = 3 V$	I <sub>OL</sub> = 48 mA			0.55				1	
		I <sub>OL</sub> = 64 mA	)L = 64 mA							
	V <sub>CC</sub> = 3.6 V,	$V_I = V_{CC} \text{ or } GND$	Control inputs			±1			±1	
lį	$V_{CC} = 0 \text{ or MAX}^{\ddagger},$	V <sub>I</sub> = 5.5 V	Control inputs			10			10	
	V <sub>CC</sub> = 3.6 V	V <sub>I</sub> = 5.5 V				100			20	μΑ
		$V_I = V_{CC}$	A or B ports§			1			1	
		$V_{I} = 0$	1			-5			-5	
loff	$V_{CC} = 0,$	$V_{I}$ or $V_{O} = 0$ to 4.5	5 V						±100	μΑ
ha in		V <sub>I</sub> = 0.8 V	A or B porto	75			75			A
l(hold)	$V_{CC} = 3 V$	V <sub>I</sub> = 2 V	A or B ports	-75			-75			μA
IOZH	V <sub>CC</sub> = 3.6 V,	$V_{O} = 3 V$				5			1	μΑ
IOZL	V <sub>CC</sub> = 3.6 V,	$V_{O} = 0.5 V$				-5			-1	μΑ
			Outputs high			0.09			0.09	
ICC	$V_{CC} = 3.6 V,$ $V_{I} = V_{CC} \text{ or GND}$	$I_{O} = 0,$	Outputs low			5			5	mA
			Outputs disabled			0.09			0.09	
$\Delta I_{CC}\P$	$V_{CC} = 3 V \text{ to } 3.6 V,$ Other inputs at $V_{CC}$		– 0.6 V,			0.2			0.2	mA
Ci	VI = 3 V or 0				4			4		pF
Cio	$V_{O} = 3 V \text{ or } 0$				11			11		pF

<sup>†</sup> All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C. <sup>‡</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>§</sup> Unused pins at V<sub>CC</sub> or GND

This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.



#### SN54LVT16245A, SN74LVT16245A 3.3-V ABT 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS SCBS143E - MAY 1992 - REVISED JANUARY 1996

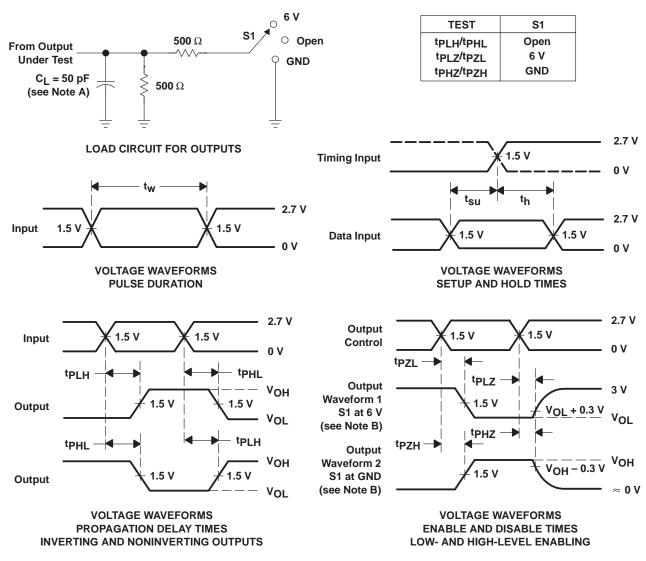
# switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

			5	SN54LV	Г16245А			SN74	LVT162	45A		
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 2.7 V		2.7 V V <sub>CC</sub> = 3.3 V ± 0.3 V		V	V <sub>CC</sub> = 2.7 V		UNIT
			MIN	MAX	MIN	MAX	MIN	TYP <sup>†</sup>	MAX	MIN	MAX	
<sup>t</sup> PLH	A or B	B or A	0.5	4.4		5.3	1	2.4	4.1		5	ns
<sup>t</sup> PHL		AUB	BUIA	0.5	4.7		5.5	1	2.3	4.1		5.2
<sup>t</sup> PZH	OE	A or B	0.5	7		7.7	1	3	5.3		6.3	ns
<sup>t</sup> PZL	ÛE	AUB	0.5	5.8		7.2	1	3.1	5.2		6.7	115
<sup>t</sup> PHZ	ŌĒ	A or B	1	7.2		7.7	2.7	4.6	6.4		7.2	ns
<sup>t</sup> PLZ		AUB	1	6.3		6.5	2.6	4.3	5.8		6.1	115

<sup>†</sup> All typical values are at  $V_{CC}$  = 3.3 V,  $T_A$  = 25°C.



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#### PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

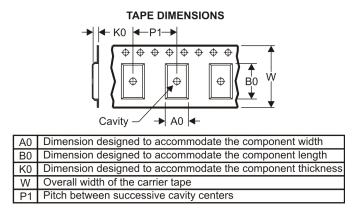
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  2.5 ns. t<sub>f</sub>  $\leq$  2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

#### Figure 1. Load Circuit and Voltage Waveforms



#### TAPE AND REEL INFORMATION





## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal	
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Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LVT16245ADLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1



## PACKAGE MATERIALS INFORMATION

11-Mar-2008



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LVT16245ADLR	SSOP	DL	48	1000	346.0	346.0	49.0

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